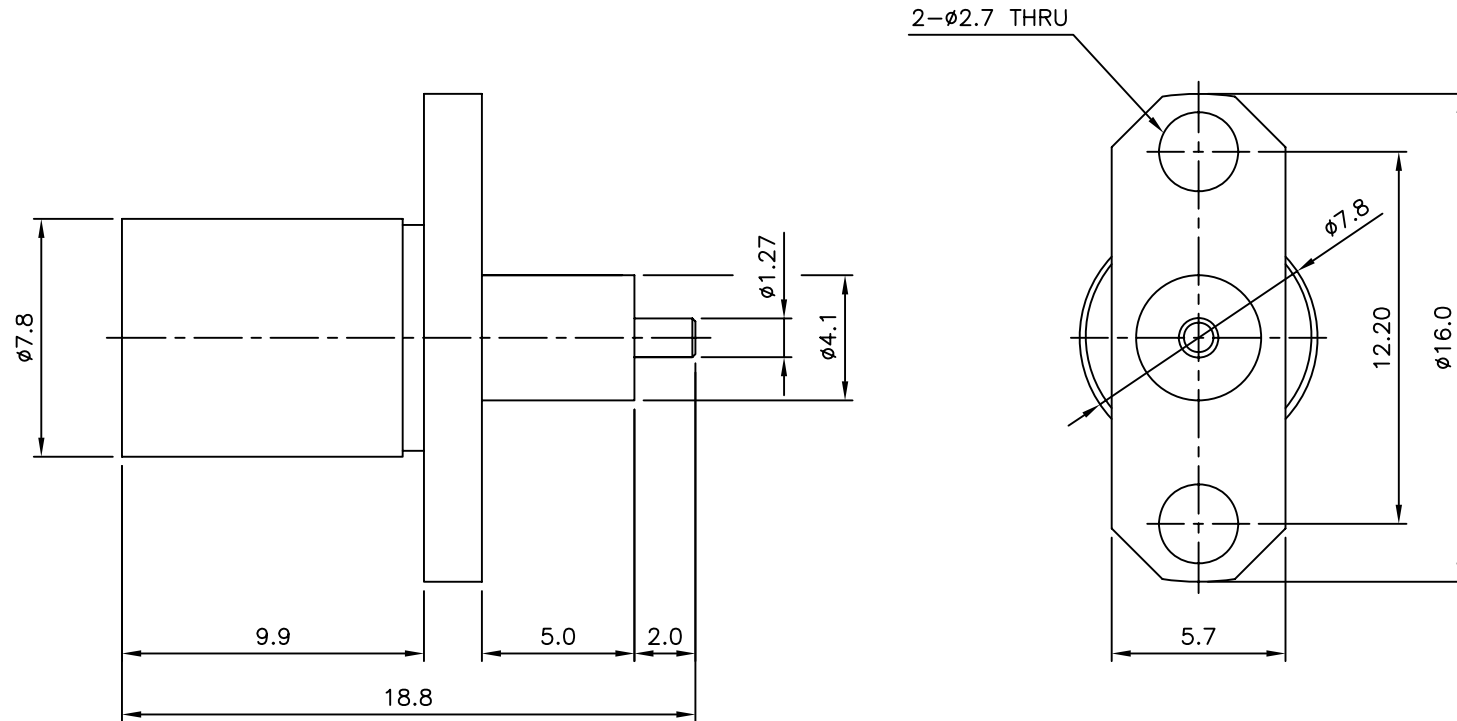


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	I.C.KIM	2013. 11. 12.
1	[설변No.201810-0003] 원가절감 및 MATING 개선으로 인한 링 삭제	S.Y.EUN	I.C.KIM	2018. 10. 10.
2	[설변No.202006-0005] 메이팅 표준화로 인한 링 재추가	S.Y.EUN	I.C.KIM	2020. 06. 16.



2	1	5	SPRING RING	1	BeCu	Nickel Plate	DSR00007-5/1
		4	CAP	1	MBsBD	Nickel Plate	DCU02182-5/1
		3	INSULATOR	1	TEFLON		DIN01894-N/1
		2	CONTACT	1	MBsBD	Gold Plate	DCT02982-5/1
		1	BODY	1	MBsBD	Nickel Plate	DBD02904-5/1
		NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 06. 16.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	_____	CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA trans($\phi 5.5$) SOLDER END PS-2H
		DRAWN BY	S.Y.EUN	
FINISH	_____	SCALE	4/1	 A4
		UNIT	mm	
		DWG NO.	CN02661-7/2	SHEET 1 of 1
		REVISION	2	